

• General Description

The AGM025N08H combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS(ON)}}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

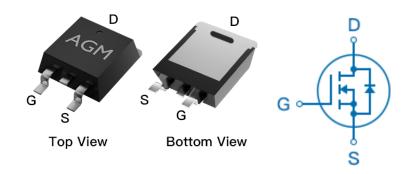
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
85V	2.3mΩ	180A

TO-263 Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM025N08H	AGM025N08H	TO-263	330mm	25mm	800

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	85	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	180	А
	Drain Current-Continuous(Tc=100℃)	145.5	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	720	А
PD	Maximum Power Dissipation(Tc=25℃)	250	w
	Maximum Power Dissipation(Tc=100℃)	100	w
EAS	Avalanche energy (Note 3)	1681	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		62.5	°C/W
RθJC	Thermal Resistance Junction-Case ¹		0.50	°C/W



Table 3. Electrical Characteristics (TJ=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta	ates					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	85	95		V
IDSS	Zero Gate Voltage Drain Current	VDS=85V,VGS=0V			1	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2	3	4	V
gFS	Forward Transconductance	VDS=5V,ID=20A		15		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=50A		2.3	3.0	mΩ
Dynamic (Characteristics					
Ciss	Input Capacitance	VDS=42.5V,		8237		pF
Coss	Output Capacitance	VGS=0V, F=1MHZ		1549		pF
Crss	Reverse Transfer Capacitance			152		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz				Ω
Switching	Times					
td(on)	Turn-on Delay Time			32		nS
tr	Turn-on Rise Time	VGS=10V,VDS=42.5V, RGEN=3Ω		115		nS
td(off)	Turn-Off Delay Time			93		nS
tf	Turn-Off Fall Time			140	-	nS
Qg	Total Gate Charge	VGS=10V, VDS=42.5V, ID=50A		138.3		nC
Qgs	Gate-Source Charge			39.5		nC
Qgd	Gate-Drain Charge	- VDG 42.6V, ID 66/1		36.8		nC
Source-Dr	rain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				180	А
VSD	Forward on Voltage	VGS=0V,IS=50A			1.2	V
trr	Reverse Recovery Time	IF=50A , dI/dt=100A/μs ,		80		ns
Qrr	Reverse Recovery Charge	TJ=25℃		196		nc

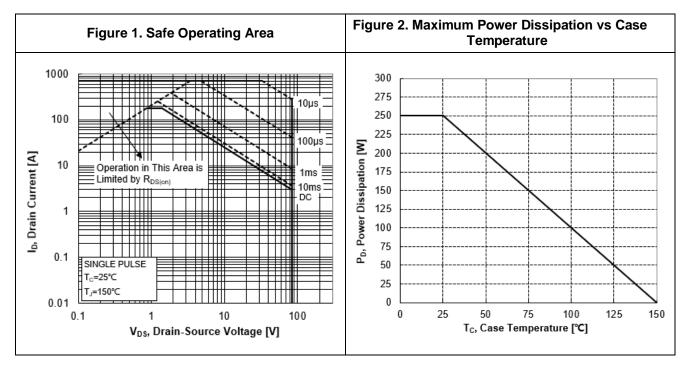
Notes 1. The maximum current rating is package limited.

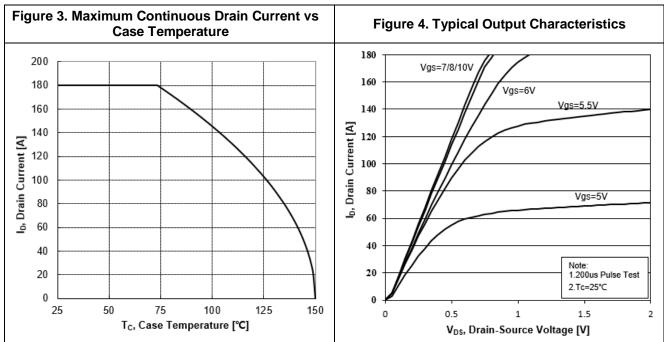
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}$ C,VDD=40V,Vgs=10V, ID=82A,L=0.5mH,RG=25ohm

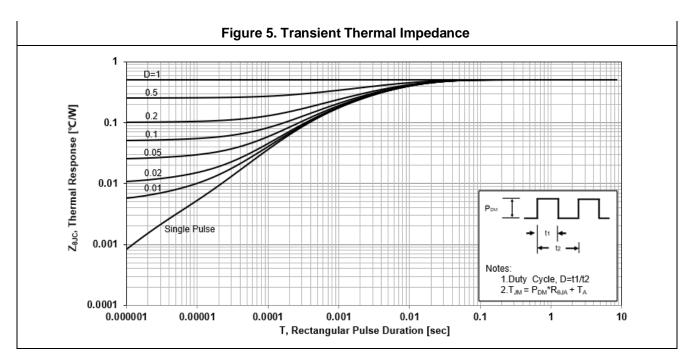


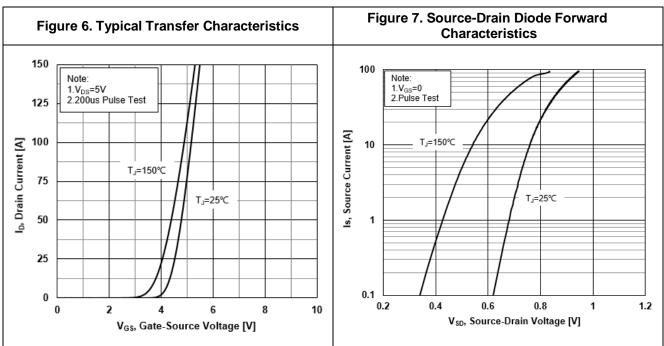
Characteristics Curves



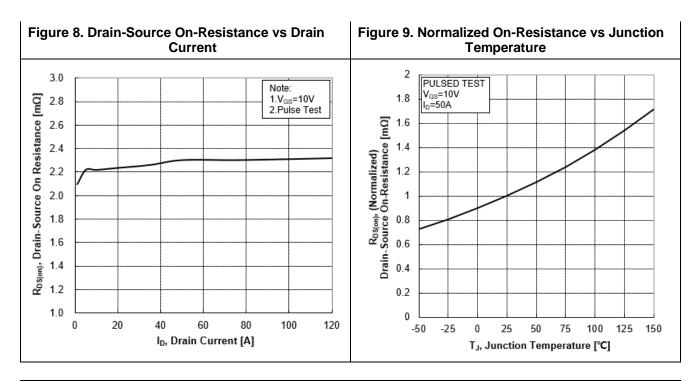


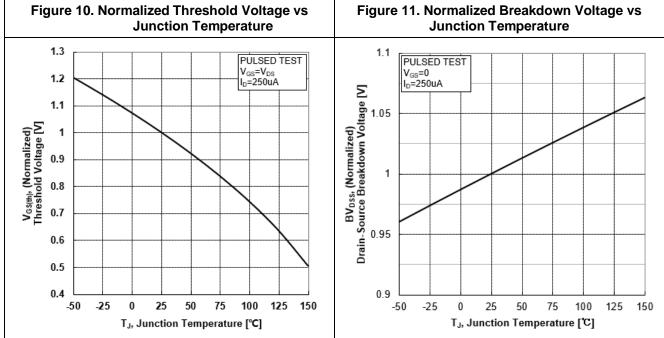




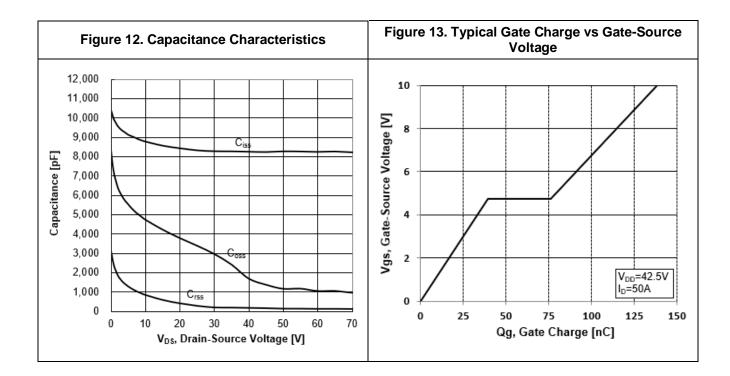






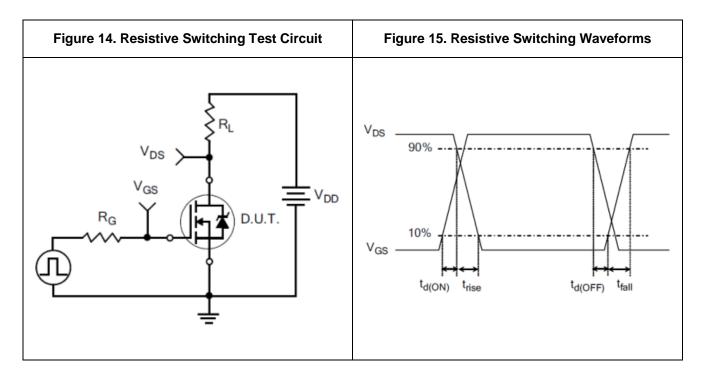


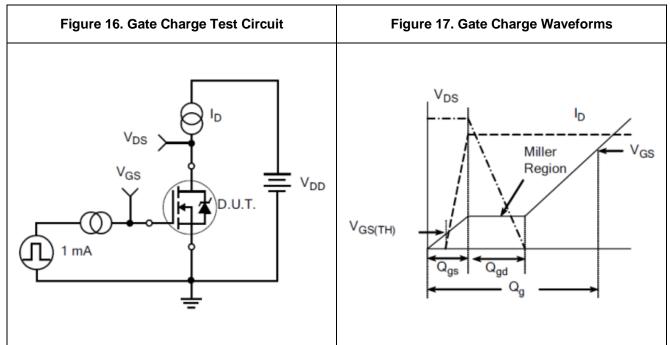




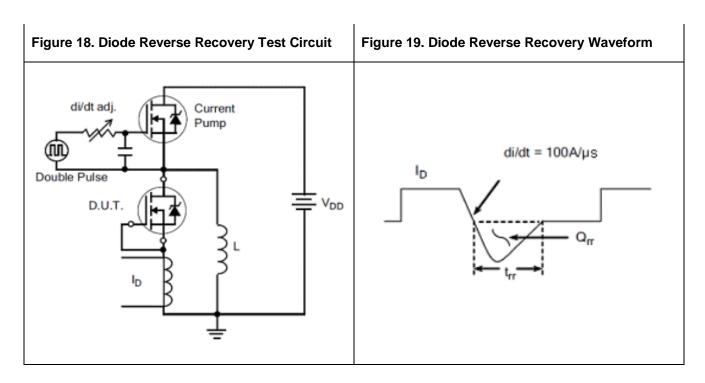


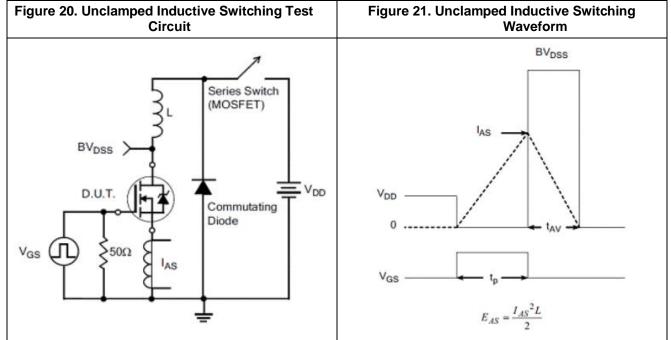
Test Circuit and Waveform





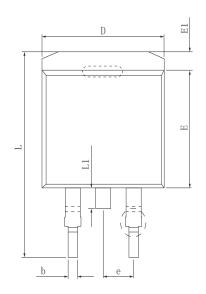


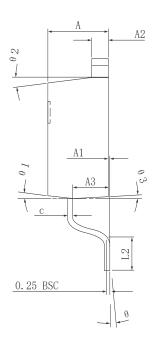


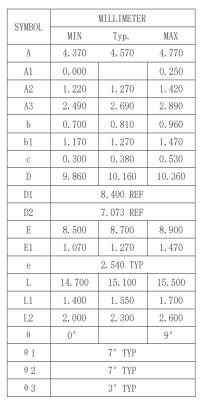


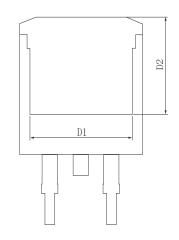


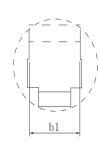
•Dimensions (TO-263)

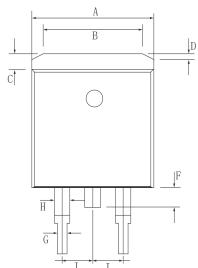


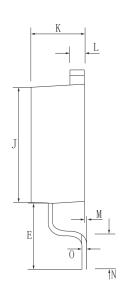








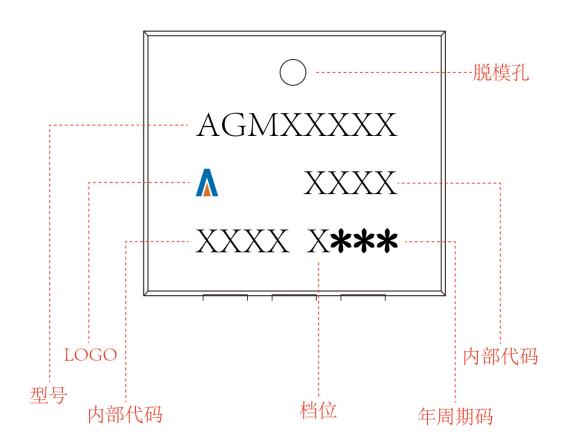




Dim.	Min.	Max.			
A	9.8	10.2			
В	6. 1	6. 7			
С	1. 1	1.4			
D	0.5	1.0			
Е	4.6	5.0			
F	1.4	1.6			
G	0.7	0.9			
Н	1. 17	1. 37			
Ι	Тур2. 54				
J	9	9.2			
K	4. 3	4.7			
L	1. 25	1. 35			
M	0.02	0. 23			
N	2. 2	2.8			
0	0.45	0.55			
All Dimensions in millimeter					



TO-263 Marking Instructions:





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